



#### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>A</sub> = +25°C
60V	3.0Ω @ V <sub>GS</sub> = 10V	261mA
60 V	4.0Ω @ VGS = 4.5V	226mA

## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Motor Control
- Power Management Functions

## **Features and Benefits**

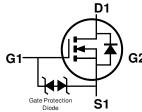
- Dual N-Channel MOSFET
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

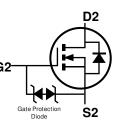
#### **Mechanical Data**

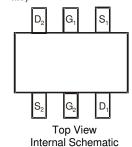
- Package: SOT363
- Package Material: Molded Plastic. "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead-Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)











Top View

**Ordering Information** (Note 4)

Part Number	Dookogo	Packing		
Part Number	Package	Qty.	Carrier	
2N7002DWK-7	SOT363	3,000	Tape & Reel	
2N7002DWK-13	SOT363	10,000	Tape & Reel	

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

**Equivalent Circuit** 

- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**

# DWK NMG N

DWK = Product Type Marking Code

 $\overline{Y}M$  = Date Code Marking  $\overline{Y}$  = Year (ex: I = 2021) M = Month (ex: 9 = September)

Date Code Key

Year	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	Н	I	J	K	L	М	N	0	Р	R	S	T
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	60	V	
Gate-Source Voltage		$V_{GSS}$	±20	V	
Continuous Drain Current (Note 6) $V_{GS} = 10V$ Steady $T_{A} = +25^{\circ}C$ State $T_{A} = +70^{\circ}C$			l <sub>D</sub>	261 208	mA
Maximum Continuous Body Diode Forward Current	(Note 6)	ls	261	mA	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	6)	IDM	1.1	Α	
Pulsed Source Current (10µs Pulse, Duty Cycle = 1	l%)		Ism	1.1	Α

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

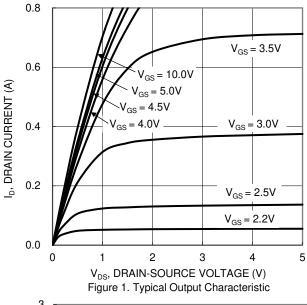
Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		$P_D$	0.33	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	379	°C/W
Total Power Dissipation (Note 6)		$P_{D}$	0.45	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{\theta JA}$	278	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

# Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 7)								
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 60V, V_{GS} = 0V$		
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$		
ON CHARACTERISTICS (Note 7)								
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.0	_	2.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$		
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	-	1.3 1.5	3.0 4.0	Ω	$V_{GS} = 10V, I_D = 200mA$ $V_{GS} = 4.5V, I_D = 150mA$		
Diode Forward Voltage	V <sub>SD</sub>	_	0.8	1.4	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = 115mA		
DYNAMIC CHARACTERISTICS (Note 8)								
Input Capacitance	C <sub>iss</sub>	_	41	—	pF	.,		
Output Capacitance	Coss	1	4.5		pF	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V f = 1.0MHz		
Reverse Transfer Capacitance	Crss	1	2.7	_	pF	1 - 1.51/11/2		
Gate Resistance	Rg	1	224	_	Ω	$f = 1MHz$ , $V_{GS} = 0V$ , $V_{DS} = 0V$		
Total Gate Charge (VGS = 4.5V)	Qg	_	0.51		nC			
Total Gate Charge (VGS = 10V)	Qg	1	1.04	_	nC	V <sub>DS</sub> = 15V,		
Gate-Source Charge	Qgs	1	0.16	_	nC	I <sub>D</sub> = 200mA		
Gate-Drain Charge	$Q_{gd}$	_	0.18	_	nC			
Turn-On Delay Time	tD(ON)	_	6.9	_	ns			
Turn-On Rise Time	tR	_	5.8	_	ns	V <sub>DD</sub> = 30V, V <sub>GS</sub> = 10V,		
Turn-Off Delay Time	tD(OFF)	_	37.8	_	ns	$R_G = 150\Omega$ , $I_D = 200mA$		
Turn-Off Fall Time	t <sub>F</sub>		14.3	_	ns			
Reverse Recovery Time	t <sub>RR</sub>	_	19	_	ns	I <sub>F</sub> = 1A, di/dt = 100A/μs		
Reverse Recovery Charge	Qrr	_	9	_	nC	I <sub>F</sub> = 1A, di/dt = 100A/μs		

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing. Notes:





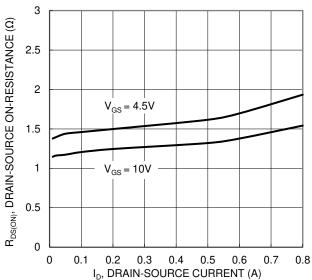


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

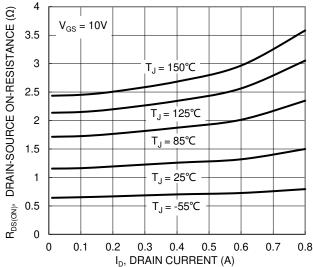
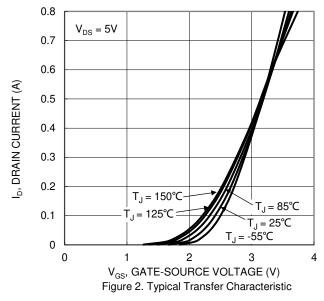
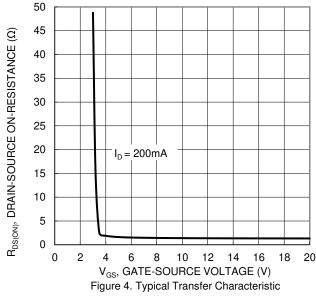


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





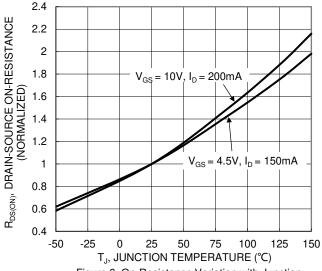


Figure 6. On-Resistance Variation with Junction Temperature



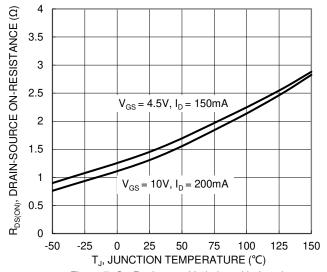
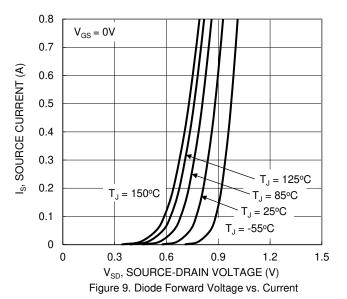
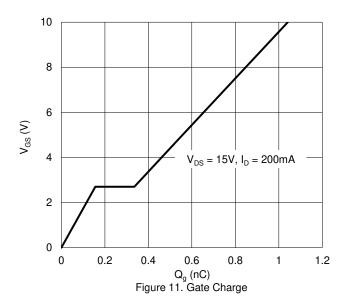


Figure 7. On-Resistance Variation with Junction Temperature





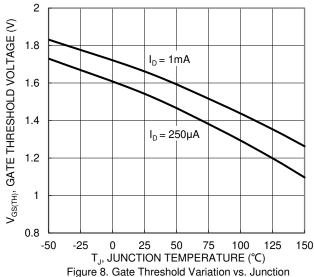
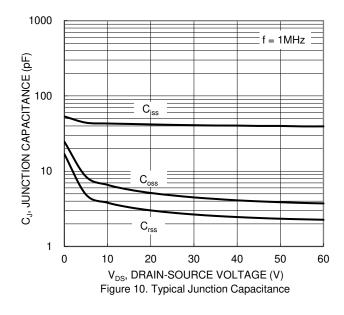
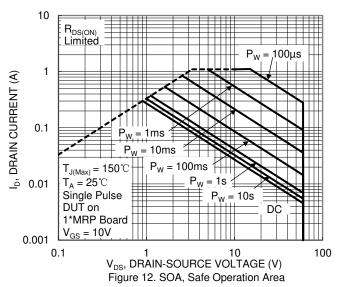


Figure 8. Gate Threshold Variation vs. Junction Temperature







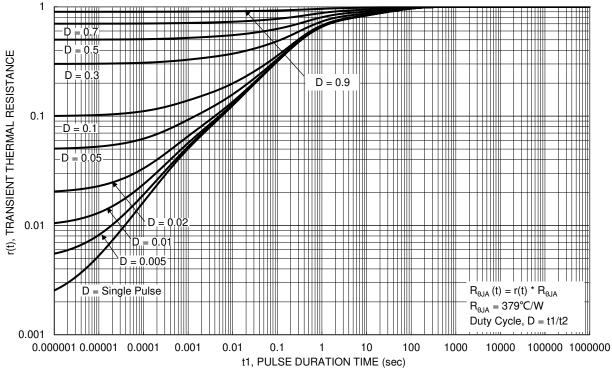


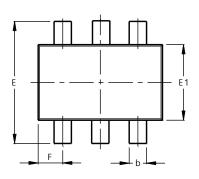
Figure 13. Transient Thermal Resistance

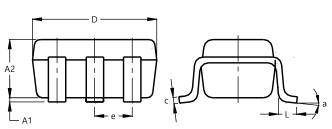


# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.





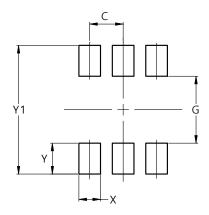


SOT363						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	0.95			
b	0.10	0.30	0.25			
С	0.10	0.22	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	0.650 BSC					
F	0.40	0.45	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All Dimensions in mm						

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOT363



Dimensions	Value (in mm)		
С	0.650		
G	1.300		
Х	0.420		
Υ	0.600		
Y1	2.500		

December 2021

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